THW



November 15, 2006

To: Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Fr:

Stephen B. Ackerman, Reg. No. 37,761

28 Davis Avenue

Poughkeepsie, N.Y. 12603

Subject:

Serial No.

10/685,872

10/15/02

M.S. LIN ET AL

"POST PASSIVATION INTERCONNECTION SCHEMES ON TOP OF THE IC CHIPS"

Group Art Unit: 2822

KEVIN M. PICARDAT

SECOND PRELIMINARY AMENDMENT

Dear Sir:

Please enter this second preliminary amendment for the above-identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 16, 2006.

Stephen B. Ackerman, Reg. No. 37,761

Signature Date 11 100

MEG-02-015 10/685,872

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of the Claims which begins on page 14 of this paper.

Amendments to the Drawings begin on page 24 of this paper and include an attached replacement sheet.

Remarks/Arguments begin on page 27 of this paper.

An Appendix including amended drawing figures is attached following page 28 of this paper.